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Туре	Silicon MOSFET type Integrated Circuit					
Application	or Switching Power Supply Control					
Structure	CMOS type	MOS type				
Equivalent Circuit	Figure 8					
Out Line	DIP7-A1-B	Marking	MIP2M4			

A. ABSOLUTE MAXIMUM RATINGS (Ta=25°C±3°C)

NO.	Item	Symbol	Ratings	Unit	Note
1	DRAIN Voltage	VD	−0.3 ~ 700	V	
2	VCC Voltage	VCC	$-0.3 \sim 45$	V	VFB is guaranteed at VDD=6 V.
3	VDD Voltage	VDD	$-0.3 \sim 9$	V	VSO is guaranteed at VSO=VDD.
4	FB Voltage	VFB	$-0.3 \sim 6.4$	V	※ 1:
5	FB Current	IFB	-500	μA	IDP is guaranteed at the pulse width
6	LS Voltage	VLS	-0.3 ~ 10	V	narrower than ton(BLK) + td(OCL)
7	SO Voltage	VSO	-0.3 ~ 9	V	
8	Output Peak Current	IDP	2.2(※1)	А	
9	Recommended Operating Temperature	Tj	$-30 \sim +125$	°C	1
10	Channel Temperature	Tch	150	°C	
11	Storage Temperature	Tstg	$-55 \sim +150$	°C	

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B. ELI	ECTRICAL CHARACTERISTICS Me	asure condit	ion (TC=25°C±3°C)				
No.	Item	Symbol	Measure Condition (Figure 1)	Тур	Min	Max	Unit
[CON	TROL FUNCTIONS] *Design guaranteed	item		1			
1	Output Frequency	fosc	※ Figure 7 V4=15 V, V3=2 V, I2=-20 μ A, V5=5 V	67	60.3	73.7	kHz
2	Jitter Frequency Deviation	d_fosc	※ Figure 7 V4=15 V, V3=2 V, I2=-20 μ Α, V5=5 V	5.0	2.4	7.6	kHz
*3	Jitter Frequency Modulation Rate	fM	※ Figure 7 V4=15 V, V3=2 V, 12=-20 μ Α, V5=5 V	360	_	_	Hz
4	Maximum Duty Cycle	MAXDC	V4=15 V, V3=2 V, I2=-20 µ A, V5=5 V	54	50	58	%
5	VDD Voltage	VDD	V4=15 V, V3=6 V, I2=−20 μ A, V5=5 V, V6=1 V	5.9	5.4	6.4	v
6	VCC Start Voltage	VCC(ON)	V3=6 V, I2=-20 µ A, V5=5 V, V6=1 V	12	11	13	v
7	VCC Stop Voltage	VCC(OFF)	V3=6 V, I2=-20 µ A, V5=5 V, V6=1 V	8.2	7.45	8.95	v
8	VCC start/stop Hysteresis	VCC(HYS)	VCC(ON) - VCC(OFF)	3.8	3.1	4.5	v
9	Feedback Threshold Current	IFB1	ON→OFF V4=15 V, V3=6 V, V5=5 V, V6=1 V	-100	-140	-60	μA
10	Feedback Current Hysteresis	IFB(HYS)	OFF→ON V4=15 V, V3=6 V, V5=5 V, V6=1 V	5	-	-	μA
11	FB Pin Voltage	VFB1	V4=15 V, V3=6 V, I2= IFB1, V5=5 V, V6=1 V	1.9	1.6	2.2	v
12	Circuit Current before start	ICC(SB)	V4=6.5 V, V3=6 V, I2=−20 μ A, V5=5 V, V6=1 V	0.25	0.20	0.30	mA
13	Circuit Current	ICC	V4=15 V, V3=6 V, I2=-20 μA, V5=5 V, V6=1 V	0.40	0.255	0.545	mA
14	VDD Charging Current	Ich1 Ich2	V1=0 V, V5=40 V V1=4 V, V5=40 V	-3.5 -2.45	-5.25 -3.8	-1.75 -1.1	mA mA
15	LS start voltage	VLSH	V4=VCC(OFF)→VCC(ON), V3=6 V, 12=-20 μ A, V5=5 V	540	486	594	mV
16	LS stop voltage	VLSL	V4=15 V, V3=6 V, 12=−20 μ A, V5=5 V	395	355	435	mV
17	LS detect Hysteresis	VLSHYS	VLSH - VLSL	145	_	_	mV
18	LS start/stop mode filter time	TLSstop	V4=15 V, V3=6 V, I2=−20 µ A, V5=5 V V6=VLSH→VLSL	5.85	4.2	7.5	ms
19	LS detect SO signal mode filter time	TLSSO	V4=15 V, V3=6 V, I2=-20 µ A, V5=5 V	3.15	1.85	4.45	ms
20	SO output voltage	vso	V4=15 V, I2=−20 µ A, V5=5 V V6=VLSH→VLSL	4.2	3.2	5.2	v

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No.	Item	Symbol	Measure Condition (Figure 1)	Тур	Min	Max	Unit
21	SO output current	ISO	V4=15 V, V3=1V, I2=-20 μ A, V5=5 V V6=0 V	-0.80	-1.2	-0.4	mA
22	SO Disable Threshold	VSOTH	V4=15 V, 12=-20 μ A, V5=5 V, V6=0 V	5.2	4.6	5.8	V
23	SO Disable Threshold margin	D_VSO	VSOTH-VSO	1.0	0.7	1.3	V
24	SO pull down current	ISO_down	V4=15 V, V3=1V, I2=-20 μ A, V5=5 V V6=0 V	0.7	0.3	1.1	μA
25	Soft start time	Tsoft	V4=VCC(OFF)→VCC(ON) I2=−20 μ A, V5=5 V, V6=1V	8.5	5	12	ms

[CIRCUIT PROTECTIONS]

26	Self Protection Current Limit		※図 5 Duty=30 %				
		ILIMIT	V4=15 V, V3=2V, V2=2.6 V, V5=adjusted	0.80	0.72	0.88	Α
27	ILIMIT modified coefficient		※図 5 Duty=10 %				mA/
		R_slope	V4=15 V, V3=2V, V2=2.6 V, V5=adjusted	23	-	-	μs
*28	Drain Current at Light Load		Ton=4.5 μ sec, V4=15 V, V3=2V,				
		ID(OFF)	I2=IFB1+2 μ A, V5=adjusted	300	120	480	mA
29	FB current at heavy load		V5=ILIMIT condition				
		IFBOLP	V4=15 V, V3=2 V, V2=3 V, V6=1 V	-10	-13	-7	μA
30	FB Over Load Protection detect		V5=ILIMIT condition				
	voltage	VFBOLP	V4=15 V, V3=2 V, V6=1 V	3.85	3.5	4.2	V
31							
	FB Over Load Protection Hysteresis	HYSVFBOLP		0.65	-	-	V
32	FB discharge current at timer		V5=ILIMIT condition, V4=VCC(OFF)				
	intermittent	IFBOLPP	V3=2 V, V2=25 V, V6=1 V	1.0	0.6	1.4	mA
33	FB current at MAXDC detect		V4=15 V, V3=6 V, V2=3 V,				
		IFBMAXDC	V5=5 V, V6=1 V	_	-	0.2	μA
34	Timer intermittent function		※図 3 V4=VCC(ON)⇔VCC(OFF).				
			V5=ILIMIT condition,				
		TIMER	V3=6 V, I2=-20 µ A, V6=1 V		4		
35	Timer intermittent function disabled at		※図 4 V4=VCC(ON)⇔VCC(OFF),				
	MAXDC	TIMER2	V5=5 V,		1		
			V3=6 V, I2=-20 µ A, V6=1 V		'	r	
*36	Leading Edge Blanking Delay	(
		ton(BLK)		290	230	350	ns
*37	Current Limit Delay						
		td(OCL)		150	100	200	ns
38	VCC Over Voltage Protection						
		VCC(OV)	V3=6 V, I2=-20 µ A, V5=5 V, V6=1 V	30	27	33	V
39	VDD Latch Voltage		V4=15 V, I1=IDD(OV), V3=0 V,				
		VDD(OV)	I2=-20 μ A, V5=5 V, V6=6 V	7.0	6.40	7.50	V
40	VDD Latch Current		V4=15 V, V3=0 V, I2=−20 μA,				
		IDD(OV)	V5=5 V, V6=6 V	3.5	2.4	4.6	mA
41	VDD Latch raised Voltage						
		D_VDDOV	VDD(OV)-VDD	0.90	0.4	1.5	V

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No.	Item	Symbol	Measure Condition (Figure 1)	Тур	Min	Max	Unit
*42	Thermal Shutdown Temperature						
		TOTP		140	130	150	°C
43	Latch Reset VDD Threshold						
		VDDreset		2.7	1.8	3.5	V

[OUTPUT]

No.	Item	Symbol	Measure Condition (Figure 1)	Тур	Min	Max	Unit
44	ON-State Resistance	RDS(ON)	V4=15 V, V3=2 V I5=100 mA, I2=-20 μ A, V6=1 V	7	_	9.5	Ω
45	OFF-State leakage Current	IDSS	V4=35 V, I2=-20 μ A, V3=6 V, V5=650 V, V6=1 V	10	_	20	μA
46	Breakdown Voltage	VDSS	V4=35 V, I2=-20 μ A, V3=6 V, I5=100 μ A, V6=1 V	-	700	-	v
*47	Rise Time	tr	※Figure 6 V4=15 V, V3=1 V, 12=-20 μ A, V5=5 V	100	_	_	ns
*48	Fall Time	tf	※Figure 6 V4=15 V, V3=1 V, I2=-20 μ A, V5=5 V	50	-	-	ns

[SUPPLY VOLTAGE]

49	Drain Supply Voltage					
		VD(MIN)	-	50	-	V

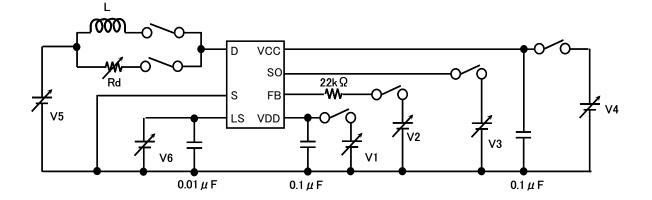
Power MOSFET is tested under the condition as below.

①VDSS>750V

②IDSS714V∕IDSS400V<1.1

(IDSS714V:Leakage current of VDSS=714V、 IDSS400V:Leakage current of VDSS=400V)

[Figure 1: Measure circuit]

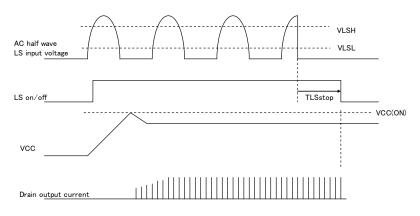


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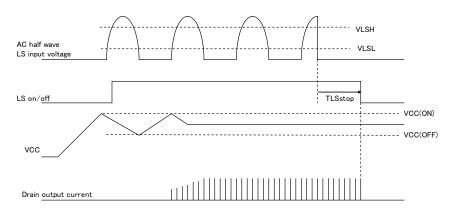
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[Figure 2: Start up and Stop diagram]

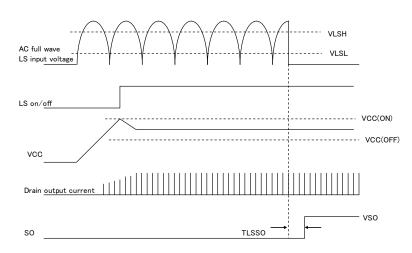
(A) Usual start and stop of LS start/stop mode (SO is connected to VDD)



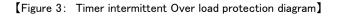
 $\left(B\right)$ Slow start and stop of LS start/stop mode (SO is connected to VDD)

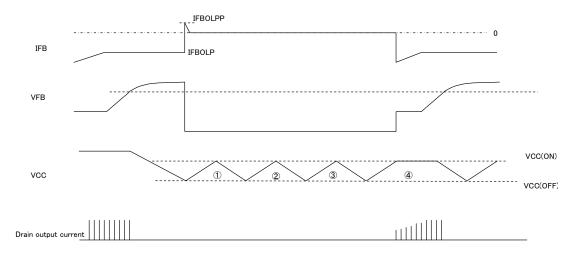


(C) Usual start and stop of LS detect SO signal mode (SO is connected to external parts)

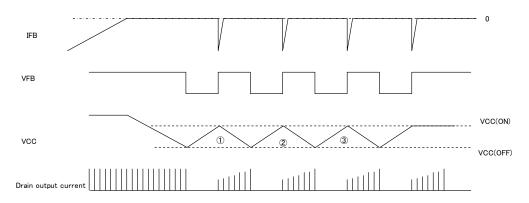


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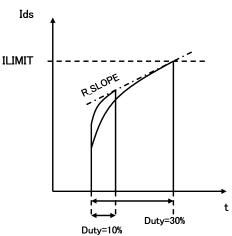


[Figure 4: OLP is disabled when MAXDC operation]



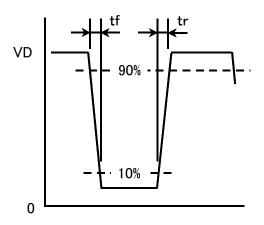
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[Figure 5: ILIMIT, R_Slope measurement]

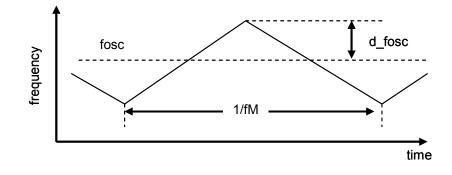


 $R_slope ; \{(ILIMIT at Duty=30\%) - (ILIMIT at Duty=10\%)\} / \{(Ton at Duty=30\%) - (Ton at Duty=10\%)\} / (Ton at Duty=10\%)\} / (Ton at Duty=30\%) - (Ton at Duty=10\%)\}$

[Figure 6: tr, tf measurement]



[Figure 7: d_fosc, fM measurement]

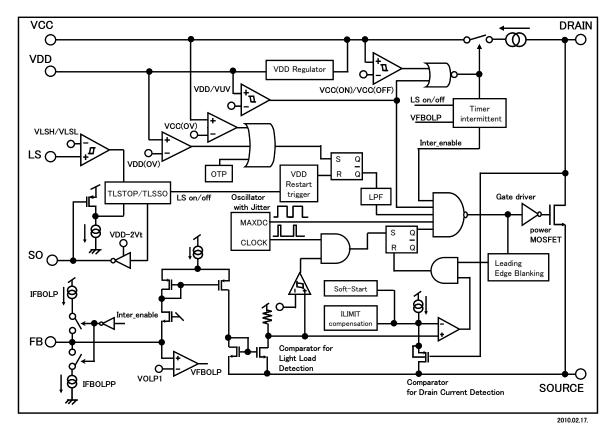


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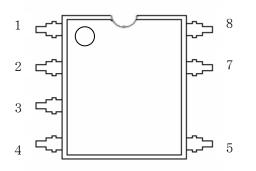
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[Figure 8: Block Diagram]



[Figure 9: Pin Layout]



Pin No.	Terminal Name
1	VDD
2	FB
3	SO
4	VCC
5	Drain
6	—
7	Source
8	LS

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[Precautions for Use 1]

Connect a ceramic capacitor with value >0.1 μ F between VDD pin and GND.

[Precautions for Use 2]

The IPD has risks for break-down or burst or giving off smoke in following conditions. Avoid the following use.

Fuse should be added at the input side or connect zener diode between control pin and GND, etc as a countermeasure to pass regulatory Safety Standard. Concrete countermeasure could be provided individually. However, customer should make the final judgment.

- (1) Reverse the DRAIN pin and VDD pin connection to the power supply board.
- (2) DRAIN pin short to VDD pin.
- (3) DRAIN pin short to FB pin.
- (4) DRAIN pin short to SO pin.
- (5) DRAIN pin short to VCC pin.
- (6) DRAIN pin short to LS pin.
- (7) VCC pin short to VDD pin.
- (8) VCC pin short to FB pin.
- (9) VCC pin short to SO pin.
- (10) VCC pin short to LS pin.

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- (5) When designing your equipment, comply with the range of absolute maximum rating and the guaranteed operating conditions (operating power supply voltage and operating environment etc.). Especially, please be careful not to exceed the range of absolute maximum rating on the transient state, such as power-on, power-off and mode-switching. Otherwise, we will not be liable for any defect which may arise later in your equipment.

Even when the products are used within the guaranteed values, take into the consideration of incidence of break down and failure mode, possible to occur to semiconductor products. Measures on the systems such as redundant design, arresting the spread of fire or preventing glitch are recommended in order to prevent physical injury, fire, social damages, for example, by using the products.

(6) Comply with the instructions for use in order to prevent breakdown and characteristics change due to external factors (ESD, EOS, thermal stress and mechanical stress) at the time of handling, mounting or at customer's process. When using products for which damp-proof packing is required, satisfy the conditions, such as shelf life and the elapsed time since first opening the packages.

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- The sale and/or the export of IPD products to customers located in certain countries is restricted by the Agreement made and executed by and between Power Integrations, Inc. and Panasonic Corporation. For details, refer to the following Attached table "IPD availability by customer."
- 2) IPD products purchased from our company, or its authorized agents, hereinafter referred to as our company, shall be used only for production purposes by those parties who have duly purchased IPD products. Those who have purchased IPD products shall not use such IPD products in unmodified form for re-sale, loan, or sample shipment for evaluation purposes to any other parties.
- 3) If a party who has duly purchased IPD products subcontracts its production to any other parties, including its subsidiaries or any other third parties inside and/or out of Japan, and the IPD products are consigned to such subcontracting parties thereat, such party is obligated to monitor and control the quantity of IPD products to prevent any of the aforementioned re-sale, loan or sample shipments from taking place.
- 4) In the event that any actual or threatened breach or violation of any of the above mentioned 2) or 3) has occurred or is about to occur, our company will hold all shipments of IPD products and may request the customer to disclose necessary documentation describing the status of our end-users and/or distribution channels.

Note) The products of MIP50**, MIP51**, and MIP7** are excluded from above-mentioned precautions, 1) to 3).

Attached table "IPD availability by customer"

	Parts No.		Companies/areas to which products can be sold	Companies/areas to which products cannot be sold	Application
MIP01** MIP2** MIP9A**	MIP02** MIP3** MIP9L**	MIP1** MIP4**	 Japanese companies in Japan Japanese companies in Asia (50% or more owned) 	 Companies in European and American countries Asian companies in Asia Other local companies 	 For power supply For DC-DC converter
MIP00** MIP55** MIP803/804	MIP52** MIP56** MIP816/826	MIP53** MIP5S** MIP9E**	 Japanese companies in Japan Japanese companies in Asia (50% or more owned) Asian companies in Asia 	 Companies in European and American countries Other local companies 	 For power supply For EL driver For LED lighting driver
MIP50**	MIP51**	MIP7**	• No restrictions in terms of contract	• No restrictions in terms of contract	· For lamp driver/ car electronics accessories

Note) For details, contact our sales division.